

# Surface Mount Schottky Barrier Rectifiers

1 A, 20 V - 150 V



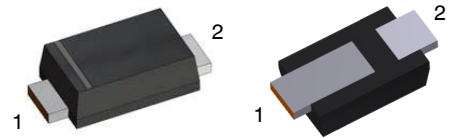
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## SS12FP - S115FP

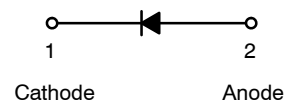
### Features

- Larger Cathode Pad for Improved Power Dissipation
- Ultra Thin Profile – Package Height < 1.0 mm
- High Surge Current Capability
- Low Power Loss, High Efficiency
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- AEC-Q101 Qualified
- These Devices are Pb-Free and are RoHS Compliant



Band Indicates Cathode

SOD-123EP  
CASE 425AC

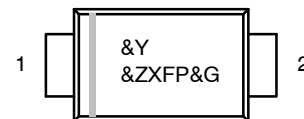


### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value						Unit
		SS12 FP	SS13 FP	SS14 FP	SS16 FP	S110 FP	S115 FP	
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	20	30	40	60	100	150	V
V <sub>RMS</sub>	RMS Reverse Voltage	14	21	28	42	70	105	V
V <sub>R</sub>	DC Blocking Voltage	20	30	40	60	100	150	V
I <sub>F(AV)</sub>	Average Forward Rectified Current	1						A
I <sub>FSM</sub>	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	30						A
T <sub>J</sub>	Operating Junction Temperature Range	-55 to +125		-55 to +150				°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +150						°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### MARKING DIAGRAM



- &Y = Binary Calendar Year Coding
- &Z = Assembly Plant Code
- XFP = Specific Device Code  
X = 0, 2, 3, 4, 6, A
- &G = Single Digit Week Code

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

## SS12FP – S115FP

### THERMAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) (Note 1)

Symbol	Parameter	Value	Unit
$\Psi_{JL}$	Thermal Characteristics, Junction-to-Lead (Note 2)	10	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	140	$^\circ\text{C}/\text{W}$

- Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
- Thermocouple soldered at cathode lead.

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Value						Unit
			SS12 FP	SS13 FP	SS14 FP	SS16 FP	S110 FP	S115 FP	
$V_F$	Maximum Instantaneous Forward Voltage (Note 3)	$I_F = 0.5 \text{ A}$			0.51	0.58	0.70	0.75	V
		$I_F = 1.0 \text{ A}$	0.45	0.50	0.55	0.70	0.80	0.90	
$I_R$	Maximum Reverse Current at Rated $V_R$	$T_J = 25^\circ\text{C}$	0.40				0.05		mA
		$T_J = 125^\circ\text{C}$					0.50		
$C_J$	Typical Junction Capacitance	$V_R = 4 \text{ V}$ , $f = 1 \text{ MHz}$	54				28		pF
$T_{rr}$	Typical Reverse Recovery Time	$I_F = 0.5 \text{ A}$ , $I_R = 1 \text{ A}$ , $I_{RR} = 0.25 \text{ A}$	6				14		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- Pulse test with  $PW = 300 \mu\text{s}$ , 1% duty cycle.

### ORDERING INFORMATION

Part Number	Device Code Marking	Package	Packing Method <sup>†</sup>
SS12FP	2FP	SOD-123EP	Tape and Reel
SS13FP	3FP	SOD-123EP	Tape and Reel
SS14FP	4FP	SOD-123EP	Tape and Reel
SS16FP	6FP	SOD-123EP	Tape and Reel
S110FP	0FP	SOD-123EP	Tape and Reel
S115FP	AFP	SOD-123EP	Tape and Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# SS12FP - S115FP

## TYPICAL PERFORMANCE CHARACTERISTICS

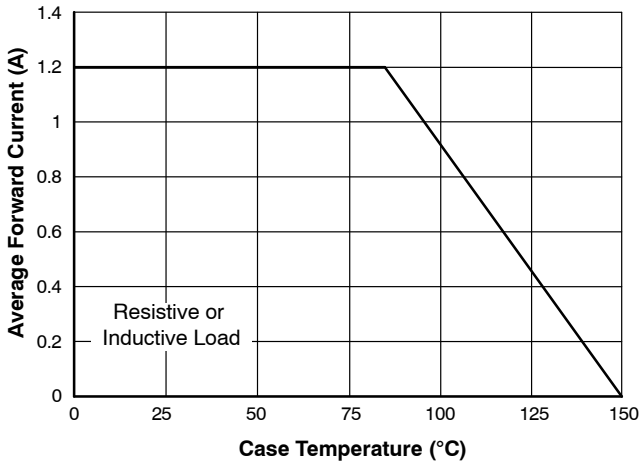


Figure 1. Forward Current Derating Curve

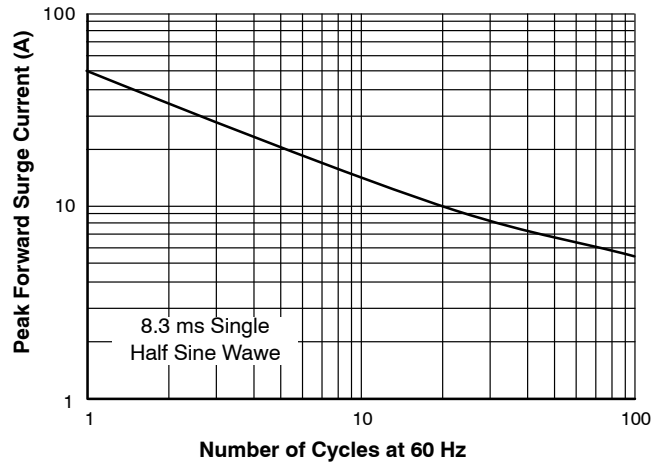


Figure 2. Maximum Non-Repetitive Forward Surge Current

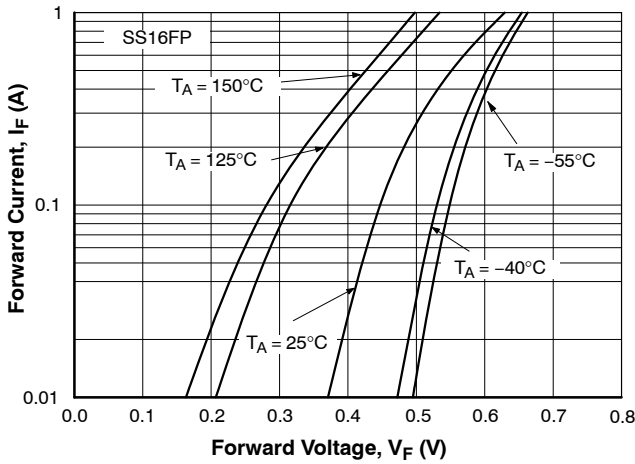


Figure 3. Typical Forward Characteristics

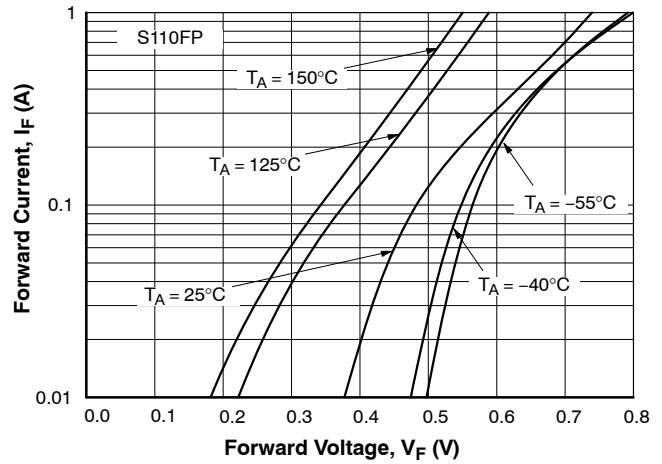


Figure 4. Typical Forward Characteristics

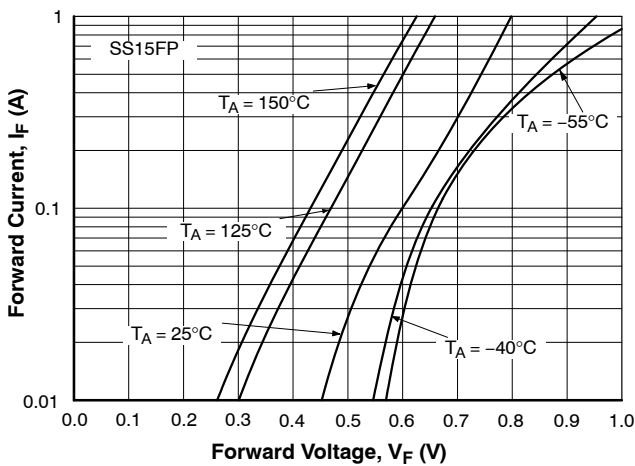


Figure 5. Typical Forward Characteristic

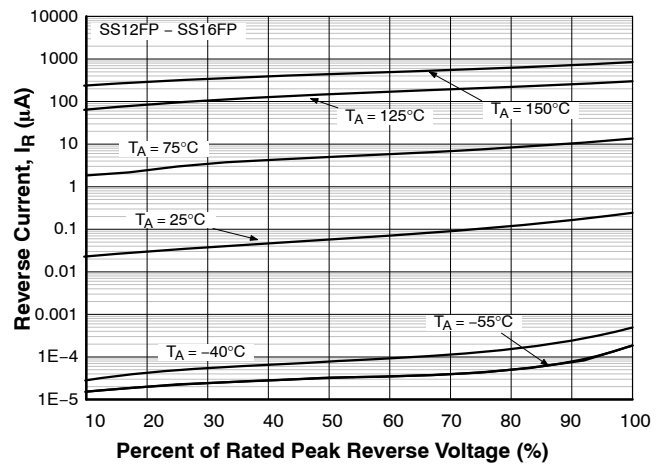


Figure 6. Typical Reverse Characteristics

# SS12FP - S115FP

## TYPICAL PERFORMANCE CHARACTERISTICS

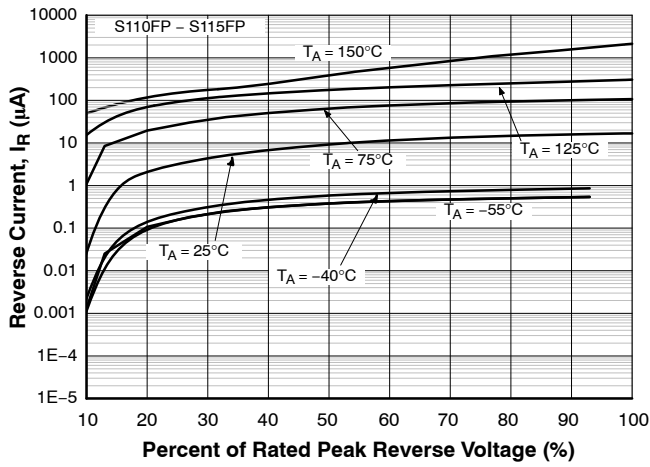


Figure 7. Typical Reverse Characteristic

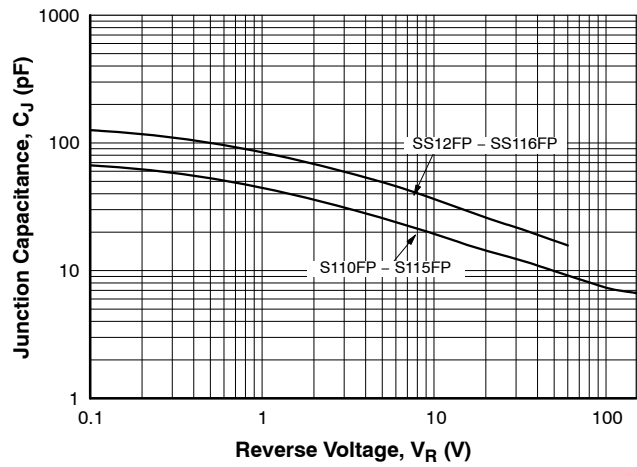


Figure 8. Typical Junction Capacitance

# MECHANICAL CASE OUTLINE

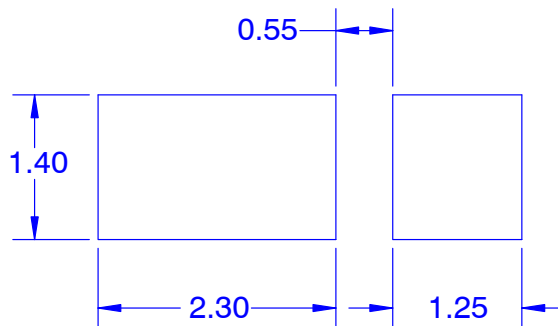
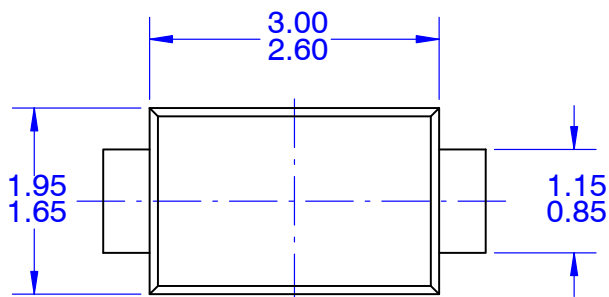
## PACKAGE DIMENSIONS

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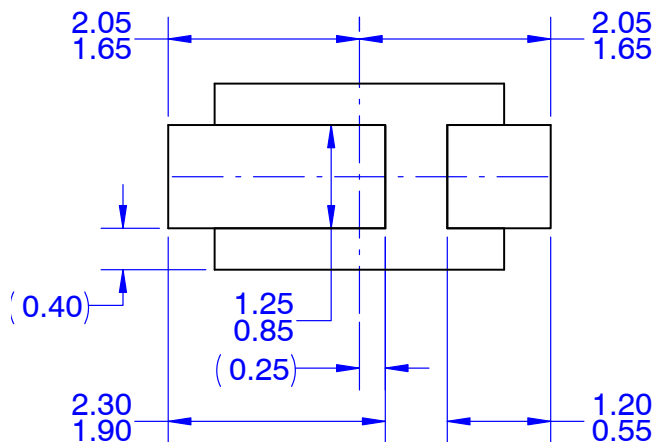
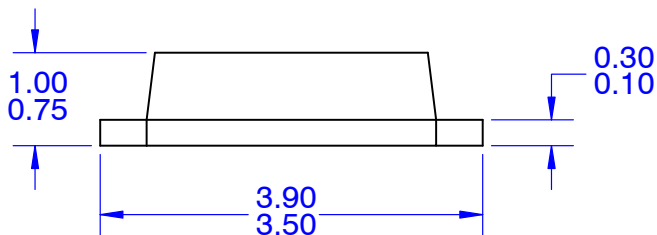


SOD-123EP  
CASE 425AC  
ISSUE O

DATE 31 AUG 2016



LAND PATTERN RECOMMENDATION  
LONG PAD IS CATHODE



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- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

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